

*N-Channel Enhancement Mode Power Mosfet*

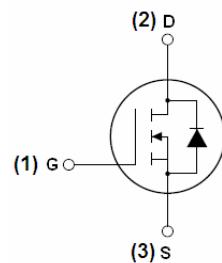
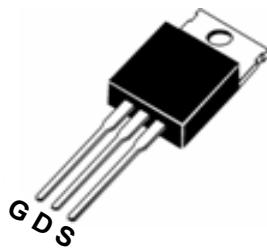
## Description

The FIR110N055PG uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

## General Features

- $V_{DS} = 55V, I_D = 110A$   
 $R_{DS(ON)} < 6m\Omega @ V_{GS}=10V$  (Typ:4.5mΩ)
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high  $E_{AS}$
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

## PIN Connection TO-220



## Application

- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

## Marking Diagram



|                                    |                     |
|------------------------------------|---------------------|
| Y                                  | = Year              |
| A                                  | = Assembly Location |
| WW                                 | = Work Week         |
| FIR110N055P = Specific Device Code |                     |

## Package Marking And Ordering Information

| Device Marking | Device       | Device Package | Reel Size | Tape width | Quantity |
|----------------|--------------|----------------|-----------|------------|----------|
| FIR110N055P    | FIR110N055PG | TO-220         | -         | -          | -        |

## Absolute Maximum Ratings (TA=25°C unless otherwise noted)

| Parameter  | Symbol              | Limit      | Unit |
|--|---------------------|------------|------|
| Drain-Source Voltage                             | $V_{DS}$            | 55         | V    |
| Gate-Source Voltage                              | $V_{GS}$            | $\pm 20$   | V    |
| Drain Current-Continuous                         | $I_D$               | 110        | A    |
| Drain Current-Continuous( $T_C=100^\circ C$ )    | $I_D (100^\circ C)$ | 78         | A    |
| Pulsed Drain Current                             | $I_{DM}$            | 440        | A    |
| Maximum Power Dissipation                        | $P_D$               | 200        | W    |
| Derating factor                                  |                     | 1.33       | W/°C |
| Single pulse avalanche energy (Note 5)           | $E_{AS}$            | 1100       | mJ   |
| Operating Junction and Storage Temperature Range | $T_J, T_{STG}$      | -55 To 175 | °C   |

**Thermal Characteristic**

|   |                  |      |      |
|---|------------------|------|------|
| Thermal Resistance,Junction-to-Case(Note 2) | R <sub>θJC</sub> | 0.75 | °C/W |
|---|------------------|------|------|

**Electrical Characteristics (TA=25°C unless otherwise noted)**

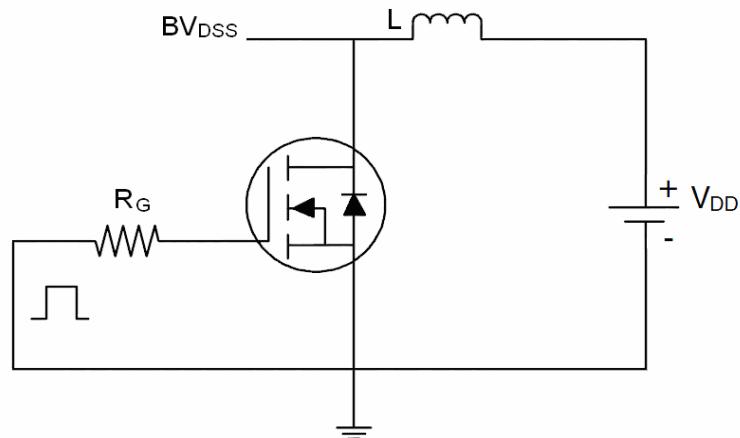
| Parameter                                 | Symbol              | Condition   | Min | Typ  | Max  | Unit |
|---|---------------------|---|-----|------|------|------|
| <b>Off Characteristics</b>                |                     |   |     |      |      |      |
| Drain-Source Breakdown Voltage            | BV <sub>DSS</sub>   | V <sub>GS</sub> =0V I <sub>D</sub> =250μA   | 55  | 65   | -    | V    |
| Zero Gate Voltage Drain Current           | I <sub>DSS</sub>    | V <sub>DS</sub> =55V, V <sub>GS</sub> =0V   | -   | -    | 1    | μA   |
| Gate-Body Leakage Current                 | I <sub>GSS</sub>    | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V  | -   | -    | ±100 | nA   |
| <b>On Characteristics (Note 3)</b>        |                     |   |     |      |      |      |
| Gate Threshold Voltage                    | V <sub>GS(th)</sub> | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA  | 2   | 3    | 4    | V    |
| Drain-Source On-State Resistance          | R <sub>DS(ON)</sub> | V <sub>GS</sub> =10V, I <sub>D</sub> =40A   | -   | 4.5  | 6    | mΩ   |
| Forward Transconductance                  | g <sub>FS</sub>     | V <sub>DS</sub> =25V, I <sub>D</sub> =40A   | 50  | -    | -    | S    |
| <b>Dynamic Characteristics (Note4)</b>    |                     |   |     |      |      |      |
| Input Capacitance                         | C <sub>iss</sub>    | V <sub>DS</sub> =25V, V <sub>GS</sub> =0V,<br>F=1.0MHz  | -   | 4900 | -    | PF   |
| Output Capacitance                        | C <sub>oss</sub>    |   | -   | 470  | -    | PF   |
| Reverse Transfer Capacitance              | C <sub>rss</sub>    |   | -   | 460  | -    | PF   |
| <b>Switching Characteristics (Note 4)</b> |                     |   |     |      |      |      |
| Turn-on Delay Time                        | t <sub>d(on)</sub>  | V <sub>DD</sub> =30V, I <sub>D</sub> =2A, R <sub>L</sub> =15Ω<br>V <sub>GS</sub> =10V, R <sub>G</sub> =2.5Ω | -   | 20   | -    | nS   |
| Turn-on Rise Time                         | t <sub>r</sub>      |   | -   | 19   | -    | nS   |
| Turn-Off Delay Time                       | t <sub>d(off)</sub> |   | -   | 70   | -    | nS   |
| Turn-Off Fall Time                        | t <sub>f</sub>      |   | -   | 30   | -    | nS   |
| Total Gate Charge                         | Q <sub>g</sub>      | V <sub>DS</sub> =30V, I <sub>D</sub> =30A,<br>V <sub>GS</sub> =10V  | -   | 125  | -    | nC   |
| Gate-Source Charge                        | Q <sub>gs</sub>     |   | -   | 24   | -    | nC   |
| Gate-Drain Charge                         | Q <sub>gd</sub>     |   | -   | 49   | -    | nC   |
| <b>Drain-Source Diode Characteristics</b> |                     |   |     |      |      |      |
| Diode Forward Voltage (Note 3)            | V <sub>SD</sub>     | V <sub>GS</sub> =0V, I <sub>S</sub> =40A  | -   | 0.85 | 1.2  | V    |
| Diode Forward Current (Note 2)            | I <sub>S</sub>      | T <sub>j</sub> =25°C, I <sub>F</sub> =75A, di/dt=100A/μs (Note3)  | -   | -    | 110  | A    |
| Reverse Recovery Time                     | t <sub>rr</sub>     |   | -   | 37   | -    | nS   |
| Reverse Recovery Charge                   | Q <sub>rr</sub>     |   | -   | 58   | -    | nC   |
| Forward Turn-On Time                      | t <sub>on</sub>     | Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)  |     |      |      |      |

**Notes:**

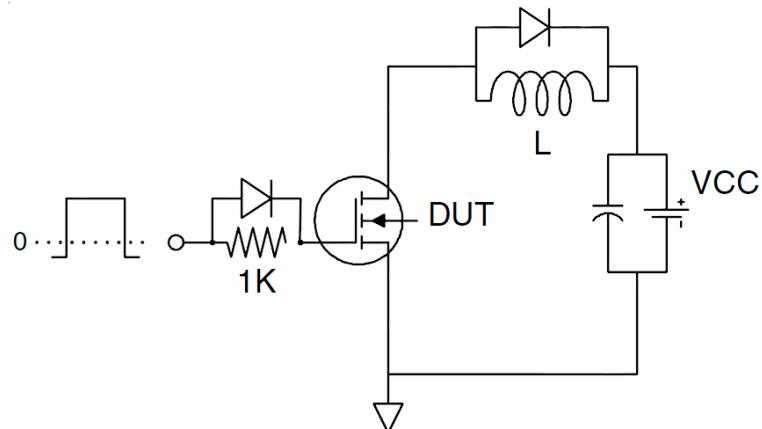
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition: T<sub>j</sub>=25°C, V<sub>DD</sub>=28V, V<sub>G</sub>=10V, L=0.5mH, R<sub>g</sub>=25Ω

## Test circuit

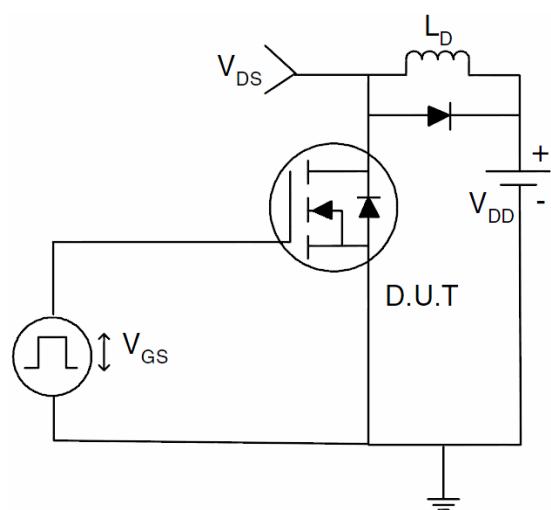
### 1) E<sub>AS</sub> test Circuits



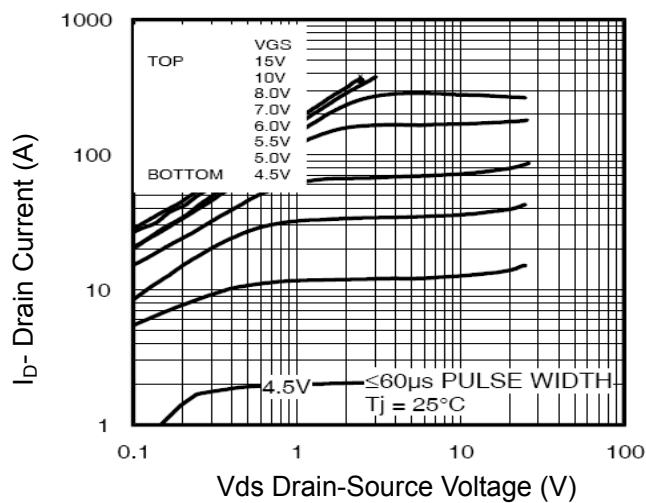
### 2) Gate charge test Circuit:



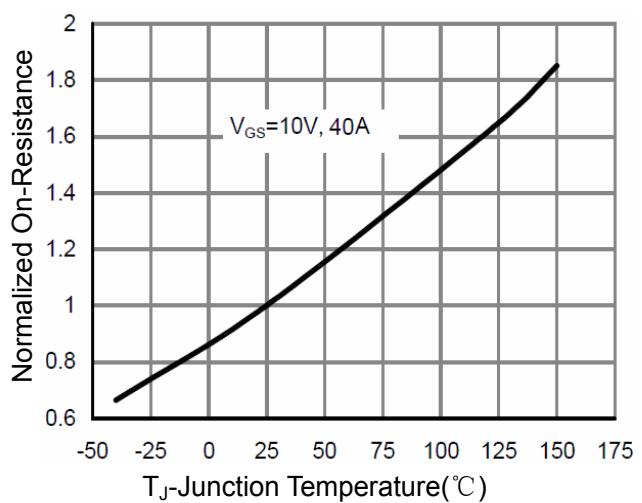
### 3) Switch Time Test Circuit:



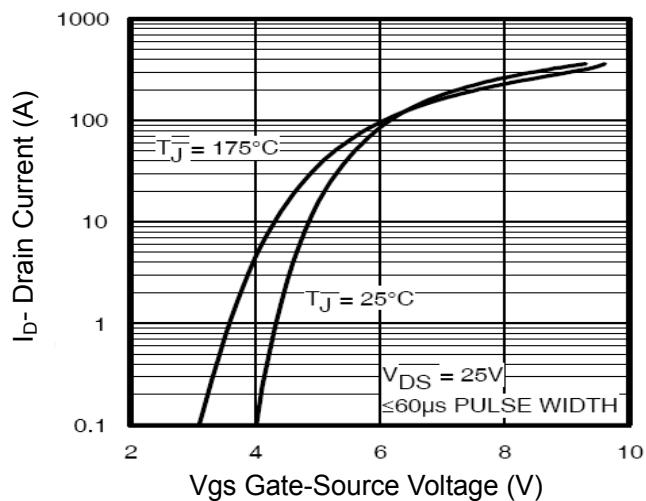
### Typical Electrical And Thermal Characteristics(Curves)



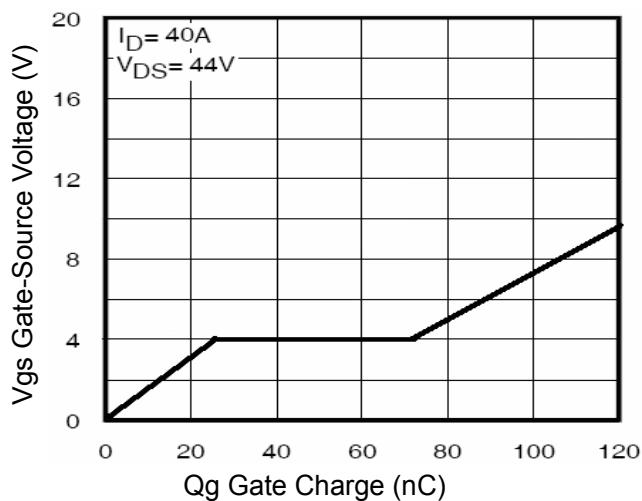
**Figure 1 Output Characteristics**



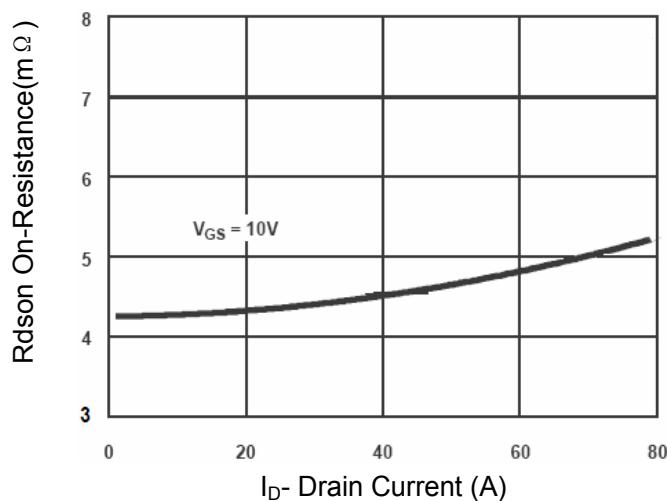
**Figure 4 Rdson-JunctionTemperature**



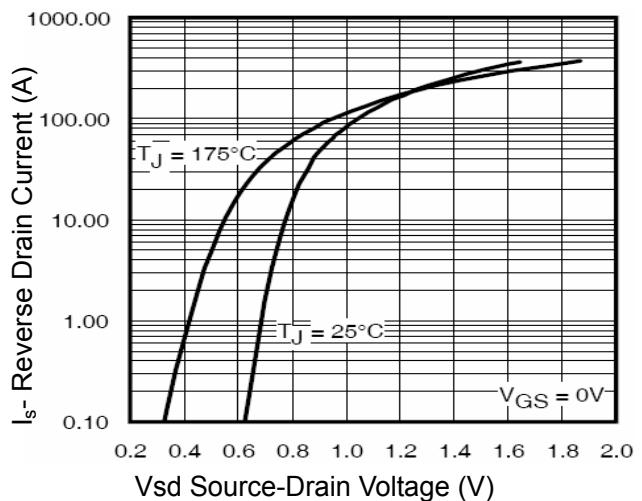
**Figure 2 Transfer Characteristics**



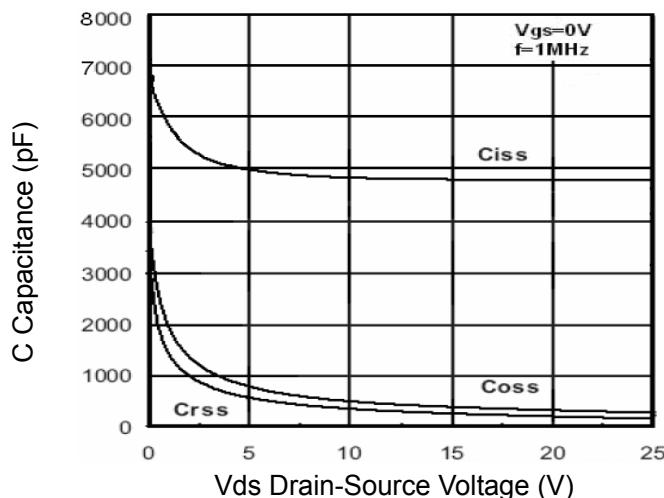
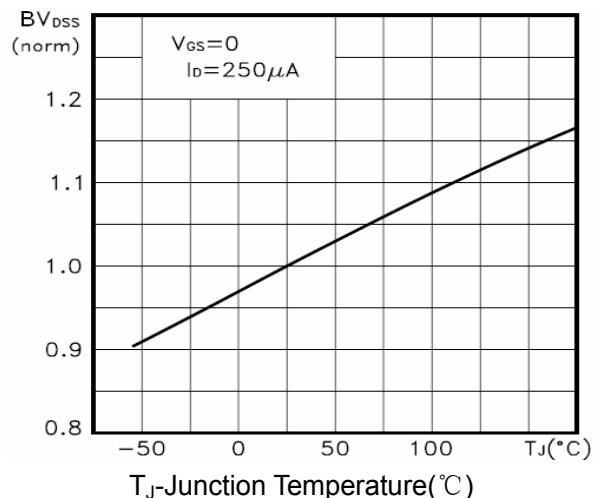
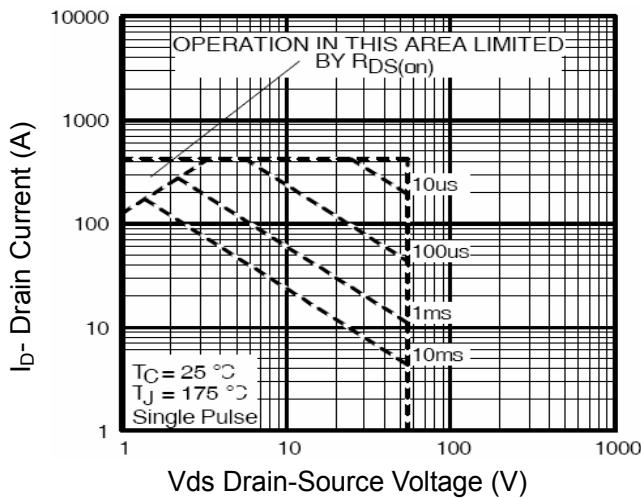
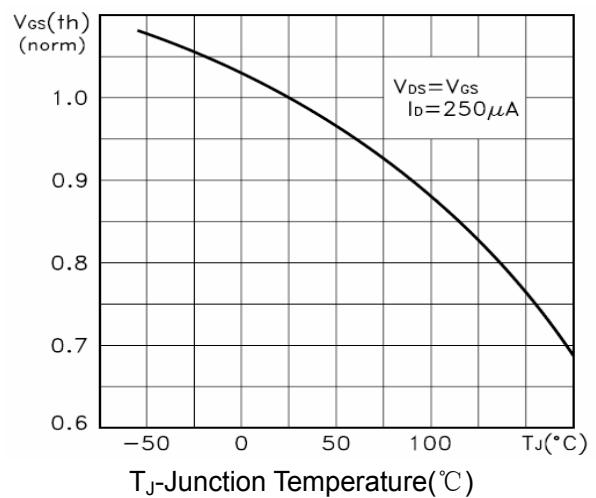
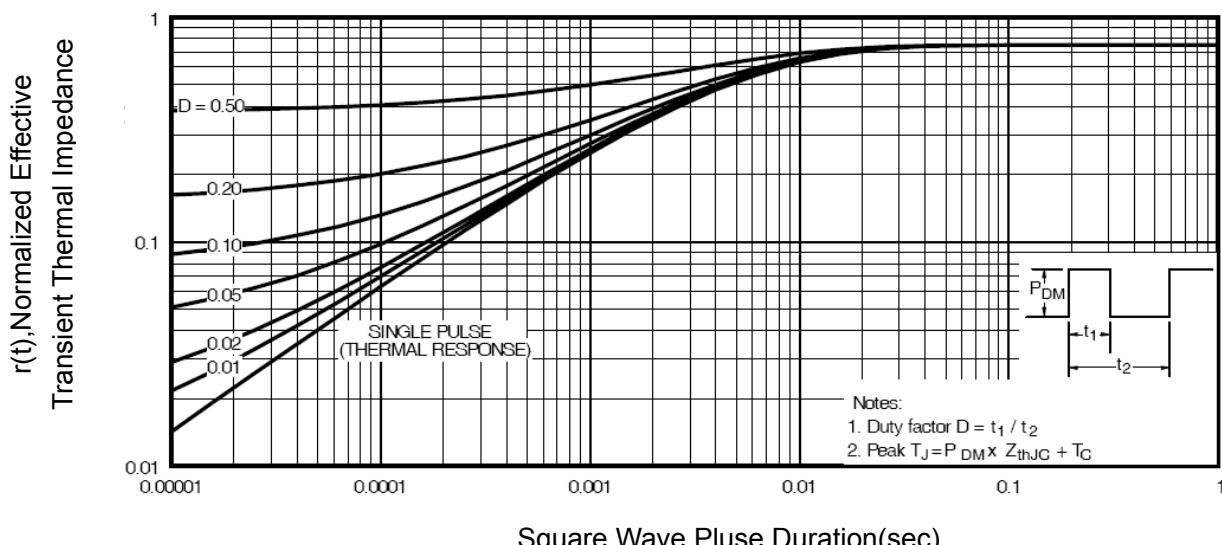
**Figure 5 Gate Charge**



**Figure 3 Rdson- Drain Current**

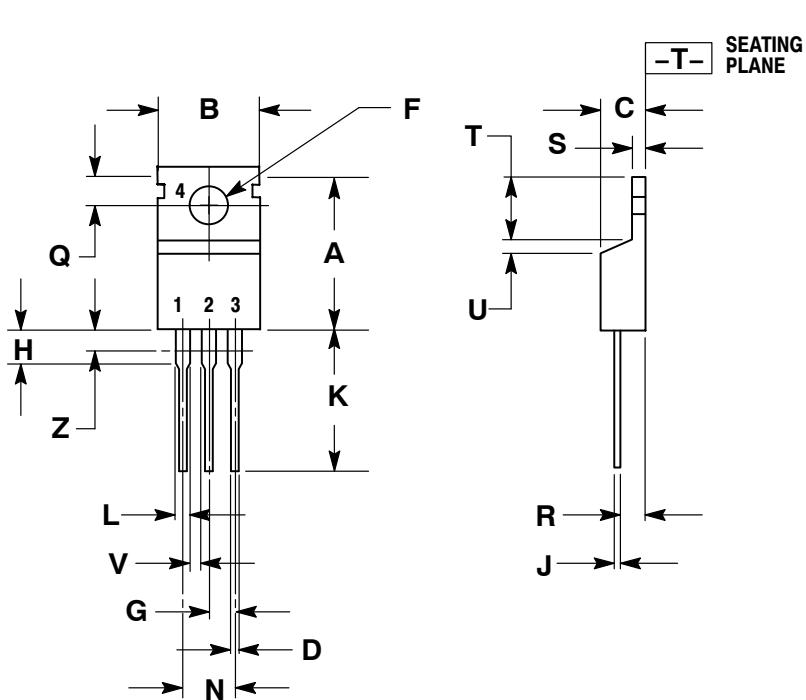


**Figure 6 Source- Drain Diode Forward**


**Figure 7 Capacitance vs Vds**

**Figure 9  $BV_{DSS}$  vs Junction Temperature**

**Figure 8 Safe Operation Area**

**Figure 10  $V_{GS(th)}$  vs Junction Temperature**

**Figure 11 Normalized Maximum Transient Thermal Impedance**

## Package Dimensions

**TO-220**



**NOTES:**

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE ALLOWED.

| DIM | INCHES |       | MILLIMETERS |       |
|-----|--------|-------|-------------|-------|
|     | MIN    | MAX   | MIN         | MAX   |
| A   | 0.570  | 0.620 | 14.48       | 15.75 |
| B   | 0.380  | 0.405 | 9.66        | 10.28 |
| C   | 0.160  | 0.190 | 4.07        | 4.82  |
| D   | 0.025  | 0.035 | 0.64        | 0.88  |
| F   | 0.142  | 0.161 | 3.61        | 4.09  |
| G   | 0.095  | 0.105 | 2.42        | 2.66  |
| H   | 0.110  | 0.155 | 2.80        | 3.93  |
| J   | 0.014  | 0.025 | 0.36        | 0.64  |
| K   | 0.500  | 0.562 | 12.70       | 14.27 |
| L   | 0.045  | 0.060 | 1.15        | 1.52  |
| N   | 0.190  | 0.210 | 4.83        | 5.33  |
| Q   | 0.100  | 0.120 | 2.54        | 3.04  |
| R   | 0.080  | 0.110 | 2.04        | 2.79  |
| S   | 0.045  | 0.055 | 1.15        | 1.39  |
| T   | 0.235  | 0.255 | 5.97        | 6.47  |
| U   | 0.000  | 0.050 | 0.00        | 1.27  |
| V   | 0.045  | ---   | 1.15        | ---   |
| Z   | ---    | 0.080 | ---         | 2.04  |

**STYLE 6:**

1. ANODE
2. CATHODE
3. ANODE
4. CATHODE